



press Mail" mailing label number <u>EL 562 521 455 US.</u>

The property August 10, 2001



## PATENT APPLICATION TRANSMITTAL LETTER

To the Commissioner for Patents:

To the Commissioner for Paterits.	L. Commonwell
Transmitted herewith for filing is the patent application of: Hanna A. I	Rempolker, Chan Lon Yang, Tito Chowdhury, and Krishnaswarny
for filing is the patent application of: Hanna A. I	Sammorker, Chan Estriction
Transmitted herewith for hing is the patent separate	1 Devices Formed

T. Ramkumar for: Methods Of Forming Semiconductor Structures Having Reduced Defects, And Articles And Devices Formed

T. Ramkumar for : Methods Of Forming Semiconductor Structures Having Reduced Defects, And Articles And Devices Former			
	Enclosed are:		
□ .	$\underline{4}$ sheet(s) of drawings, $\underline{23}$ pages of application (inclu	uding title page), and the following Appe	ndices :
	Declaration.		
	Power of Attorney.	1 27 CED 88 1 9 and 1 27.	
	Verified statement to establish small entity status ur	nder 37 CFR 99 1.5 and 1.2.1	Corp.
	Assignment transmittal letter and Assignment of the	invention to . Cypress connection	
and the second s	·		
	0.1.0	Small Entity	Other Than Small Entity

Claims as Filed	Col. 1	Col. 2
For	No. Filed	No. Extra
Basic Fee		
Total Claims	30-20	
Indep. Claims	3-3	l
Multiple Dependent Claims Present		

<sup>&</sup>quot;If the difference in col. 1 is less than zero, enter "0" in col. 2.

Small Entity			
Rate	Fee	or	
	\$ 355	or	
x\$9=	\$	or	
x\$40=	\$	01	
+\$135=	\$	01	
		0	
Total	\$		

	Small Entity			
ır İ	Rate	Fee		
r		\$ 710		
or I	10x\$18=	\$180		
or	x\$80=	\$		
or	+\$270=	\$		
or				
)	Total	\$890		

2	Please	charge my Deposit Account No. 23-1925 in the amount of \$: A duplicate copy of this sheet is enclosed.
		the filing foo is enclosed
<b>X</b>		mmissioner is hereby authorized to charge payment of the following rees associated with the constant of the following rees as a second of the constant of the following rees as a second of the constant of the following rees as a second of the constant of the constant of the following rees as a second of the constant of the
		Any additional filing fees required under 37 CFR § 1.16.
	_	under 37 CFR §1.17.
	The Co	Any patent application processing lees under or over 3 section of the following fees during the pendency of this application or commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or any overpayment to Deposit Account No. 23-1925. A duplicate copy of this sheet is enclosed.
		Any filing fees under 37 CFR § 1.16 for presentation of extra claims.
		to see under 37 CFR § 1.17.
		Any patent application processing lees under 37 GFR § 1.311(b). The issue fee set in 37 CFR § 1.18 at or before mailing of the Notice of Allowance, pursuant to 37 CFR § 1.311(b).

Paul E. Rauch, Ph.D.

BRINKS HOFER GILSON & LIONE

Registration No. 38,591

Date



Approved for use through 10/31/2002. OMB 0651-0031 U.S. Patent and Trademark Office, U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

		amed Inventor	Hailid A. Baillioine.
REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)	Title	Methods of Forming Semiconductor Structures Having Reduced Defects, and Articles and Devices Formed Thereby	
	Atty Docket Number		10200/101

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

2 hotel

Signature

Paul E. Rauch, Ph.D., Reg. No.: 38,591

Typed or Printed Name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).

Burden Hour Statement: This collection of information is required by 37 CFR 1 213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, Washington, DC 20231.